

6N135/6, HCNW135/6 HCPL-2502/0500/0501

Single Channel, High Speed Optocouplers



Data Sheet



Lead (Pb) Free
RoHS 6 fully
compliant

RoHS 6 fully compliant options available;
-xxxE denotes a lead-free product

Description

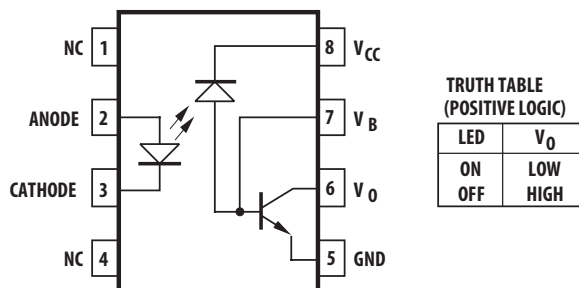
These diode-transistor optocouplers use an insulating layer between a LED and an integrated photodetector to provide electrical insulation between input and output. Separate connections for the photodiode bias and output-transistor collector increase the speed up to a hundred times that of a conventional phototransistor coupler by reducing the base-collector capacitance.

These single channel optocouplers are available in 8-Pin DIP, SO-8 and Widebody package configurations.

The 6N135, HCPL-0500, and HCNW135 are for use in TTL/CMOS, TTL/LSTTL or wide bandwidth analog applications. Current transfer ratio (CTR) for these devices is 7% minimum at $I_F = 16 \text{ mA}$.

The 6N136, HCPL-2502, HCPL-0501, and HCNW136 are designed for high speed TTL/TTL applications. A standard 16 mA TTL sink current through the input LED will provide enough output current for 1 TTL load and a 5.6 k Ω pull-up resistor. CTR for these devices is 19% minimum at $I_F = 16 \text{ mA}$.

Functional Diagram



A 0.1 μF bypass capacitor must be connected between pins 5 and 8.

Features

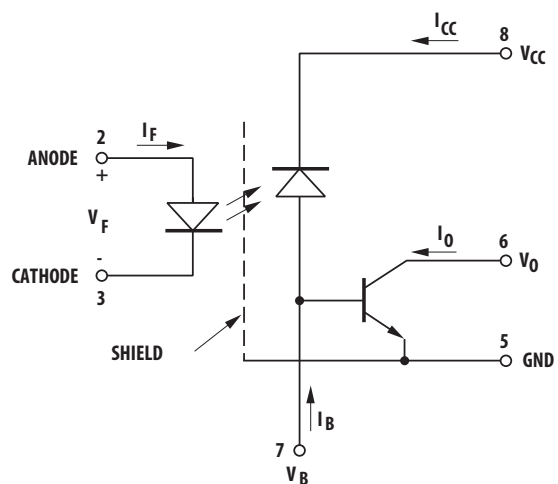
- High speed: 1 Mb/s
- TTL compatible
- Available in 8-Pin DIP, SO-8, widebody packages
- Open collector output
- Safety approval
UL Recognized – 3750 V_{rms} for 1 minute (5000 V_{rms} for 1 minute for HCNW and Option 020 devices) per UL1577
CSA Approved
IEC/EN/DIN EN 60747-5-5 Approved
 - $V_{\text{IORM}} = 567 \text{ V}$ peak for SO-8 devices
 - $V_{\text{IORM}} = 630 \text{ V}$ peak for DIP 300 mil devices
 - $V_{\text{IORM}} = 1414 \text{ V}$ peak for DIP 400 mil (widebody) devices
- Dual channel version available (253X/053X/0534)

Applications

- High voltage insulation
- Video signal isolation
- Line receivers
- Feedback element in switched mode power supplies
- High speed logic ground isolation
 - TTL/TTL, TTL/CMOS, TTL/LSTTL
- Replaces pulse transformers
- Replaces slow phototransistor isolators
- Analog signal ground isolation

CAUTION: It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.

Schematic



Selection Guide

Minimum CMR		8-Pin DIP (300 Mil)			Small-Outline SO-8		Widebody (400 Mil)
dV/dt (V/μs)	V _{CM} (V)	Current Transfer Ratio (%)	Single Channel Package	Dual Channel Package*	Single Channel Package	Dual Channel Package*	Single Channel Package
1,000	10	7	6N135	HCPL-2530	HCPL-0500	HCPL-0530	HCNW135
		19	6N136	HCPL-2531	HCPL-0501	HCPL-0531	HCNW136
		15	HCPL-2502				

*Technical data for these products are on separate Avago publications.

Ordering Information

6N135, 6N136, HCPL-2502, HCPL-0500, HCPL-0501 are UL Recognized with 3750 V_{rms} for 1 minute per UL1577.

HCNW135, HCNW136 are UL Recognized with 5000 V_{rms} for 1 minute per UL1577. All these devices are approved under CSA Component Acceptance Notice #5, File CA 88324.

Part number	Option		Package	Surface Mount	Gull Wing	Tape & Reel	UL 5000 V _{rms} / 1 Minute rating	IEC/EN/DIN EN 60747-5-5	Quantity
	RoHS Compliant	Non RoHS Compliant							
6N135 6N136 HCPL-2502	-000E	No option	300mil DIP-8						50 per tube
	-300E	#300		X	X				50 per tube
	-500E	#500		X	X	X			1000 per reel
	-020E	#020					X		50 per tube
	-320E	#320		X	X		X		50 per tube
	-520E	#520		X	X	X	X		1000 per reel
	-060E	#060						X	50 per tube
	-360E	#360		X	X			X	50 per tube
	-560E	#560		X	X	X		X	1000 per reel
HCPL-0500 HCPL-0501	-000E	No option	SO-8						100 per tube
	-500E	#500		X	X	X			1500 per reel
	-060E	#060						X	100 per tube
	-560E	#560		X	X	X		X	1500 per reel
HCNW135 HCNW136	-000E	No option	400 mil Widebody DIP-8				X	X	42 per tube
	-300E	#300		X	X		X	X	42 per tube
	-500E	#500		X	X	X	X	X	750 per reel

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

HCPL-2502-560E to order product of 300 mil DIP Gull Wing Surface Mount package in Tape and Reel packaging with IEC/EN/DIN EN 60747-5-5 Safety Approval in RoHS compliant.

Example 2:

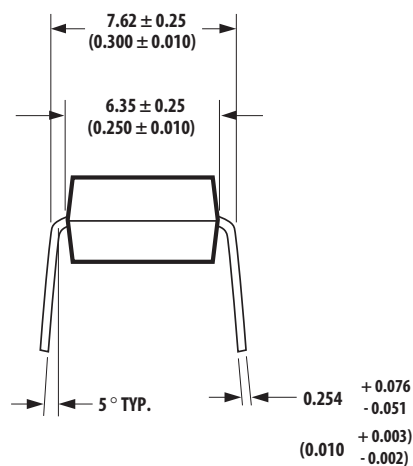
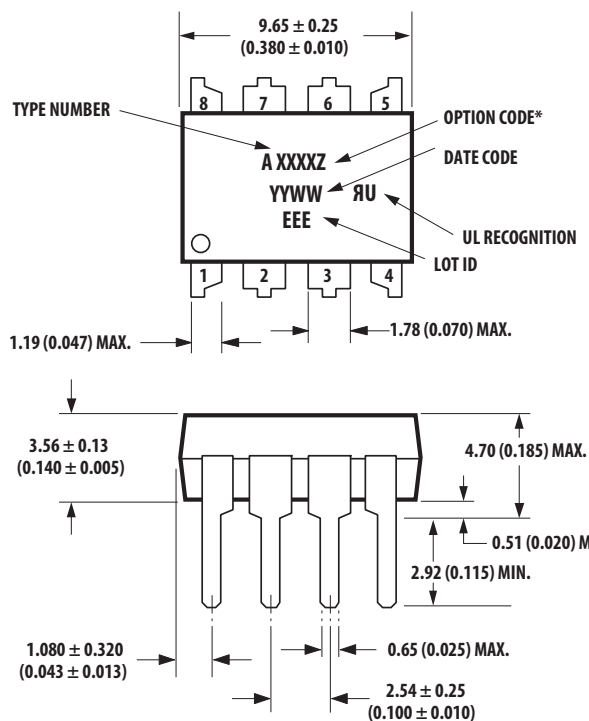
HCPL-2502 to order product of 300 mil DIP package in tube packaging and non RoHS compliant.

Option datasheets are available. Contact your Avago sales representative or authorized distributor for information.

Remarks: The notation 'XXX' is used for existing products, while (new) products launched since 15th July 2001 and RoHS compliant option will use '-XXxE'.

Package Outline Drawings

8-Pin DIP Package (6N135/6, HCPL-2502)



DIMENSIONS IN MILLIMETERS AND (INCHES).

*MARKING CODE LETTER FOR OPTION NUMBERS

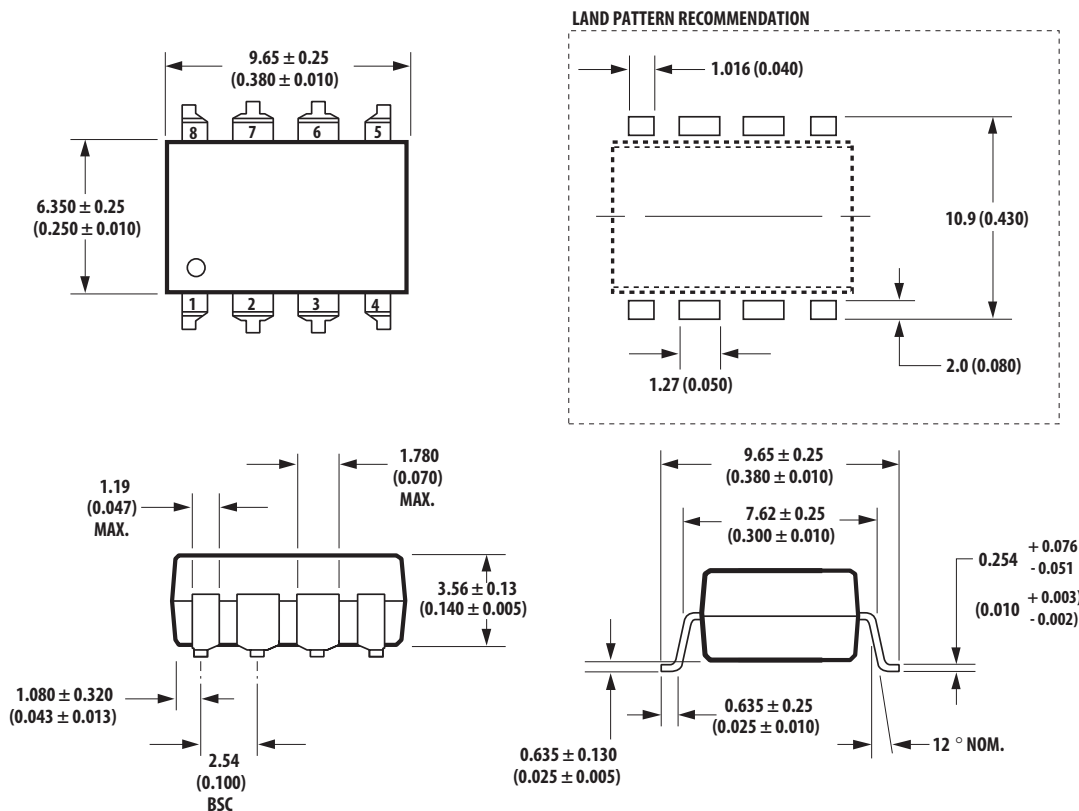
"L" = OPTION 020

"V" = OPTION 060

OPTION NUMBERS 300 AND 500 NOT MARKED.

NOTE: FLOATING LEAD PROTRUSION IS 0.25 mm (10 mils) MAX.

8-Pin DIP Package with Gull Wing Surface Mount Option 300 (6N135/6)

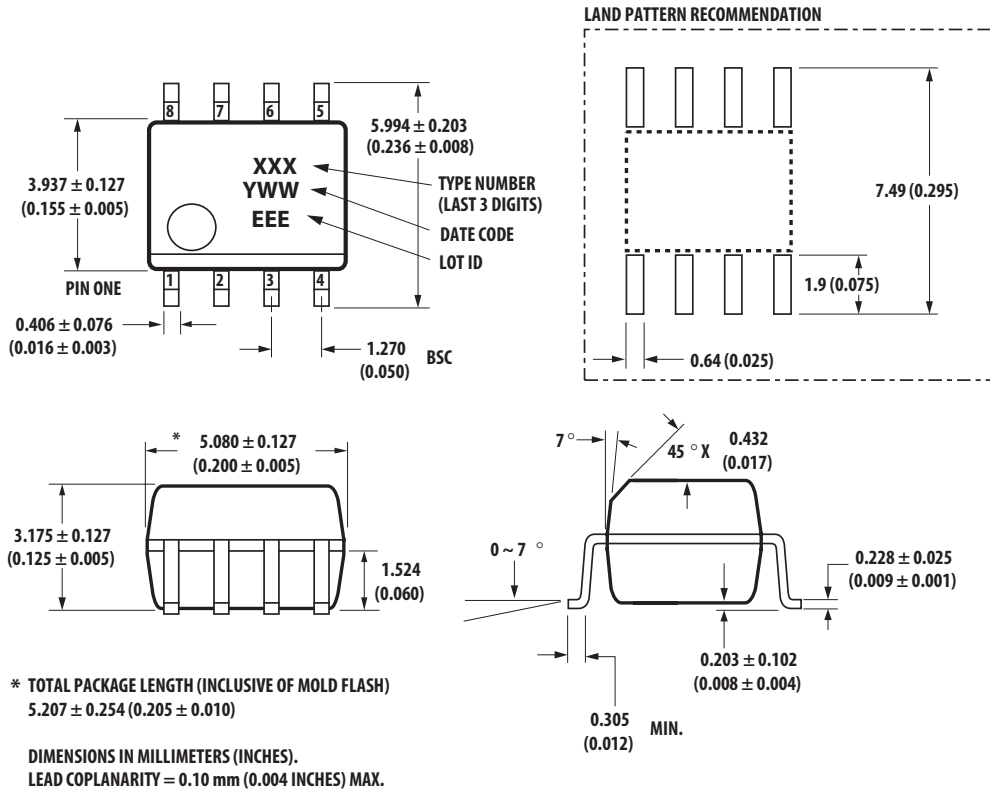


DIMENSIONS IN MILLIMETERS (INCHES).

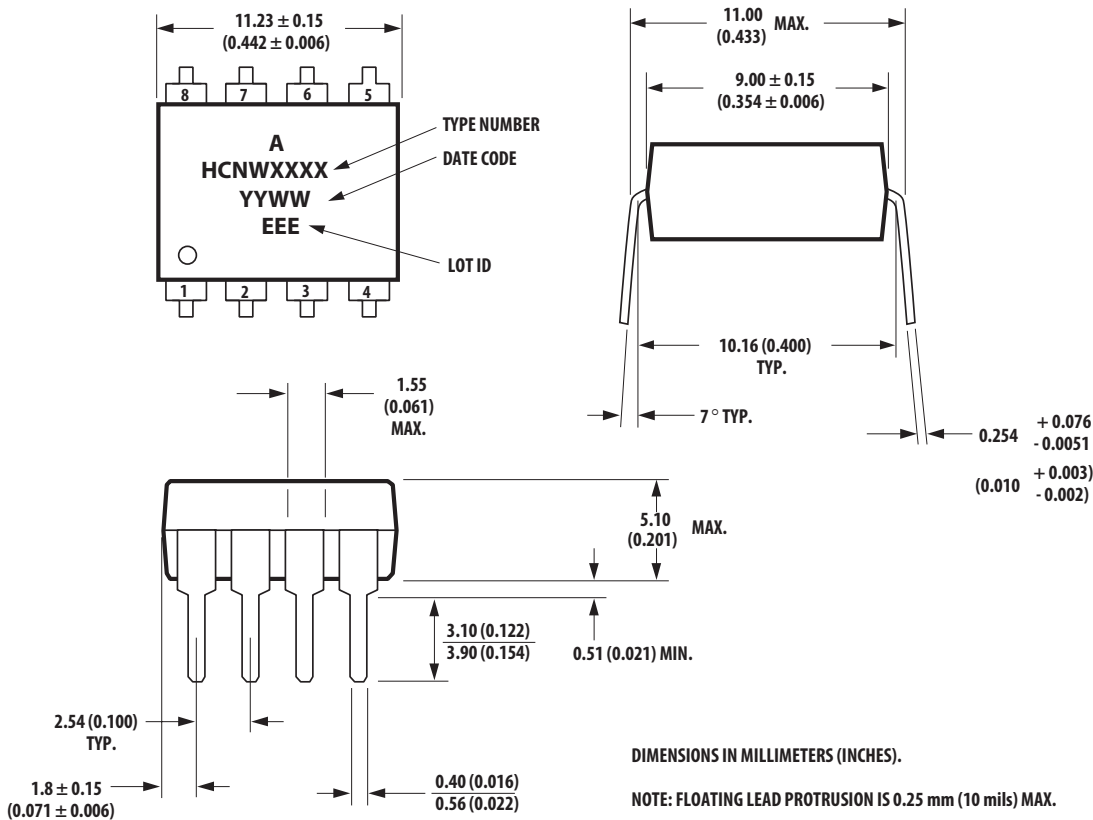
LEAD COPLANARITY = 0.10 mm (0.004 INCHES).

NOTE: FLOATING LEAD PROTRUSION IS 0.25 mm (10 mils) MAX.

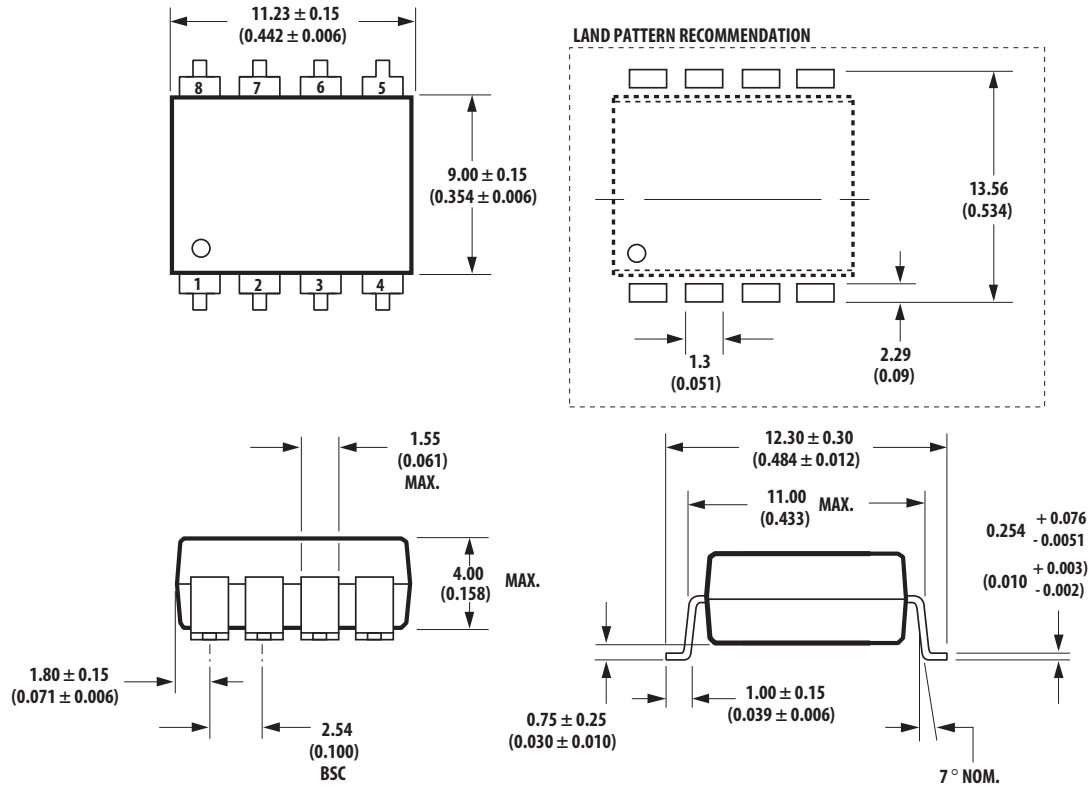
Small Outline SO-8 Package (HCPL-0500/1)



8-Pin Widebody DIP Package (HCNW135/6)



8-Pin Widebody DIP Package with Gull Wing Surface Mount Option 300 (HCNW135/6)



DIMENSIONS IN MILLIMETERS (INCHES).

LEAD COPLANARITY = 0.10 mm (0.004 INCHES).

NOTE: FLOATING LEAD PROTRUSION IS 0.25 mm (10 mils) MAX.

Solder Reflow Profile

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision). Non-Halide Flux should be used.

Regulatory Information

The devices contained in this data sheet have been approved by the following organizations:

UL	Recognized under UL 1577, Component Recognition Program, File E55361.
CSA	Approved under CSA Component Acceptance Notice #5, File CA 88324.
IEC/EN/DIN EN 60747-5-5	(HCNW and Option 060/360/560 only)

Insulation and Safety Related Specifications

Parameter	Symbol	8-Pin DIP (300 Mil) Value	SO-8 Value	Widebody (400 Mil) Value	Units	Conditions
Minimum External Air Gap (External Clearance)	L(101)	7.1	4.9	9.6	mm	Measured from input terminals to output terminals, shortest distance through air.
Minimum External Tracking (External Creepage)	L(102)	7.4	4.8	10.0	mm	Measured from input terminals to output terminals, shortest distance path along body.
Minimum Internal Plastic Gap (Internal Clearance)		0.08	0.08	1.0	mm	Through insulation distance, conductor to conductor, usually the direct distance between the photoemitter and photo-detector inside the optocoupler cavity.
Minimum Internal Tracking (Internal Creepage)		NA	NA	4.0	mm	Measured from input terminals to output terminals, along internal cavity.
Tracking Resistance (Comparative Tracking Index)	CTI	200	200	200	Volts	DIN IEC 112/VDE 0303 Part 1
Isolation Group		IIIa	IIIa	IIIa		Material Group (DIN VDE 0110, 1/89, Table 1)

Option 300 - surface mount classification is Class A in accordance with CECC 00802.

IEC/EN/DIN EN 60747-5-5 Insulation Characteristics (OPTION 060 ONLY)*

Description	Symbol	8 Pin DIP	SO-8	Unit
Installation classification per DIN VDE 0110, Table 1				
for rated mains voltage $\leq 150 V_{rms}$		I – IV	I – IV	
for rated mains voltage $\leq 300 V_{rms}$		I – IV	I – IV	
for rated mains voltage $\leq 600 V_{rms}$		I – IV	I – III	
Climatic Classification		0/70/21	0/70/21	
Pollution Degree (DIN VDE 0110/39)		2	2	
Maximum Working Insulation Voltage	V_{IORM}	630	567	V_{peak}
Input to Output Test Voltage, Method b*	V_{PR}	1181	1063	V_{peak}
$V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1$ sec, Partial discharge < 5 pC				
Input to Output Test Voltage, Method a*	V_{PR}	1008	907	V_{peak}
$V_{IORM} \times 1.6 = V_{PR}$, Type and Sample Test, $t_m = 10$ sec, Partial discharge < 5 pC				
Highest Allowable Overvoltage* (Transient Overvoltage $t_{int} = 60$ sec)	V_{IOTM}	8000	6000	V_{peak}
Safety-limiting values – maximum values allowed in the event of a failure				
Case Temperature	T_S	175	150	$^{\circ}C$
Input Current	$I_{S, INPUT}$	230	150	mA
Output Power	$P_{S, OUTPUT}$	600	600	mW
Insulation Resistance at $T_S, V_{IO} = 500$ V	R_S	$\geq 10^9$	$\geq 10^9$	Ω

* Refer to the front of the optocoupler section of the current catalog, under Product Safety Regulations section IEC/EN/DIN EN 60747-5-5, for a detailed description.

Note: Isolation characteristics are guaranteed only within the safety maximum ratings, which must be ensured by protective circuits in application.

IEC/EN/DIN EN 60747-5-5 Insulation Characteristics (HCNW135/6 OPTION 060 ONLY)*

Description	Symbol	Characteristic	Unit
Installation classification per DIN VDE 0110, Table 1			
for rated mains voltage $\leq 150 V_{rms}$		I – IV	
for rated mains voltage $\leq 300 V_{rms}$		I – IV	
for rated mains voltage $\leq 600 V_{rms}$		I – IV	
for rated mains voltage $\leq 1000 V_{rms}$		I – III	
Climatic Classification		0/70/21	
Pollution Degree (DIN VDE 0110/39)		2	
Maximum Working Insulation Voltage	V_{IORM}	1414	V_{peak}
Input to Output Test Voltage, Method b*	V_{PR}	2651	V_{peak}
$V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1$ sec, Partial discharge < 5 pC			
Input to Output Test Voltage, Method a*	V_{PR}	2262	V_{peak}
$V_{IORM} \times 1.6 = V_{PR}$, Type and Sample Test, $t_m = 10$ sec, Partial discharge < 5 pC			
Highest Allowable Overvoltage* (Transient Overvoltage $t_{int} = 60$ sec)	V_{IOTM}	8000	V_{peak}
Safety-limiting values – maximum values allowed in the event of a failure			
Case Temperature	T_S	150	$^{\circ}C$
Input Current	$I_{S, INPUT}$	400	mA
Output Power	$P_{S, OUTPUT}$	700	mW
Insulation Resistance at $T_S, V_{IO} = 500$ V	R_S	$\geq 10^9$	Ω

* Refer to the front of the optocoupler section of the current catalog, under Product Safety Regulations section IEC/EN/DIN EN 60747-5-5, for a detailed description.

Note: Isolation characteristics are guaranteed only within the safety maximum ratings, which must be ensured by protective circuits in application.

Absolute Maximum Ratings

Parameter	Symbol	Device	Min.	Max.	Units	Note
Storage Temperature*	T_S		-55	125	°C	
Operating Temperature*	T_A	8-Pin DIP SO-8	-55	100	°C	
		Widebody	-55	85		
Average Forward Input Current*	$I_{F(AVG)}$			25	mA	1
Peak Forward Input Current* (50% duty cycle, 1 ms pulse width) (50% duty cycle, 1 ms pulse width)	$I_{F(PEAK)}$	8-Pin DIP SO-8		50	mA	2
		Widebody		40		
Peak Transient Input Current* (≤1 μs pulse width, 300 pps)	$I_{F(TRANS)}$	8-Pin DIP SO-8		1	A	
		Widebody		0.1		
Reverse LED Input Voltage* (Pin 3-2)	V_R	8-Pin DIP SO-8		5	V	
		Widebody		3		
Input Power Dissipation*	P_{IN}	8-Pin DIP SO-8		45	mW	3
		Widebody		40		
Average Output Current* (Pin 6)	$I_{O(AVG)}$			8	mA	
Peak Output Current*	$I_{O(PEAK)}$			16	mA	
Emitter-Base Reverse Voltage* (Pin 5-7)	V_{EBR}			5	V	
Supply Voltage (Pin 8-5)	V_{CC}		-0.5	30	V	
Output Voltage (Pin 6-5)	V_O		-0.5	20	V	
Supply Voltage* (Pin 8-5)	V_{CC}		-0.5	15	V	
Output Voltage* (Pin 6-5)	V_O		-0.5	15	V	
Base Current* (Pin 7)	I_B			5	mA	
Output Power Dissipation*	P_O			100	mW	4
Lead Solder Temperature* (Through-Hole Parts Only) 1.6 mm below seating plane, 10 seconds up to seating plane, 10 seconds	T_{LS}	8-Pin DIP		260	°C	
		Widebody		260	°C	
Reflow Temperature Profile	T_{RP}	SO-8 and Option 300	See Package Outline Drawings section			

*Data has been registered with JEDEC for the 6N135/6N136.

Electrical Specifications (DC)

Over recommended temperature ($T_A = 0^\circ\text{C}$ to 70°C) unless otherwise specified. See note 13.

Parameter	Symbol	Device	Min.	Typ.**	Max.	Units	Test Conditions			Fig.	Note		
Current Transfer Ratio	CTR*	6N135	7	18	50	%	$T_A = 25^{\circ}\text{C}$	$V_O = 0.4\text{ V}$	$I_F = 16\text{ mA}$	1, 2, 4	5, 11		
		HCPL-0500	5	19				$V_O = 0.5\text{ V}$	$V_{CC} = 4.5\text{ V}$				
		HCNW135											
		HCPL-2502	15		22		$T_A = 25^{\circ}\text{C}$	$V_O = 0.4\text{ V}$					
			15	25				$V_O = 0.5\text{ V}$					
		6N136	19	24	50		$T_A = 25^{\circ}\text{C}$	$V_O = 0.4\text{ V}$					
		HCPL-0501	15	25			$V_O = 0.5\text{ V}$						
	HCNW136												
Logic Low Output Voltage	V_{OL}	6N135		0.1	0.4	V	$T_A = 25^{\circ}\text{C}$	$I_O = 1.1\text{ mA}$	$I_F = 16\text{ mA}$	$V_{CC} = 4.5\text{ V}$			
		HCPL-0500		0.1	0.5			$I_O = 0.8\text{ mA}$					
		HCNW135											
		6N136		0.1	0.4		$T_A = 25^{\circ}\text{C}$	$I_O = 3.0\text{ mA}$					
		HCPL-2502		0.1	0.5			$I_O = 2.4\text{ mA}$					
		HCPL-0501											
	HCNW136												
Logic High Output Current	I_{OH}^*			0.003	0.5	μA	$T_A = 25^{\circ}\text{C}$	$V_O = V_{CC} = 5.5\text{ V}$	$I_F = 0\text{ mA}$	7			
				0.01	1		$T_A = 25^{\circ}\text{C}$	$V_O = V_{CC} = 15\text{ V}$					
				50			$V_O = V_{CC} = 15\text{ V}$						
Logic Low Supply Current	I_{CCL}			50	200	μA	$I_F = 16\text{ mA}$, $V_O = \text{Open}$, $V_{CC} = 15\text{ V}$			13			
Logic High Supply Current	I_{CCH}^*			0.02	1	μA	$T_A = 25^{\circ}\text{C}$	$I_F = 0\text{ mA}$, $V_O = \text{Open}$, $V_{CC} = 15\text{ V}$		13			
				2									
Input Forward Voltage	V_F^*	8-Pin DIP		1.5	1.7	V	$T_A = 25^{\circ}\text{C}$	$I_F = 16\text{ mA}$		3			
		SO-8			1.8								
		Widebody	1.45	1.68	1.85		$T_A = 25^{\circ}\text{C}$	$I_F = 16\text{ mA}$					
			1.35		1.95								
Input Reverse Breakdown Voltage	BV_R^*	8-Pin DIP	5			V	$I_R = 10\text{ }\mu\text{A}$						
		SO-8											
		Widebody	3				$I_R = 100\text{ }\mu\text{A}$						
Temperature Coefficient of Forward Voltage	$\Delta V_F / \Delta T_A$	8-Pin DIP		-1.6		$\text{mV}/^{\circ}\text{C}$	$I_F = 16\text{ mA}$						
		SO-8											
		Widebody		-1.9									
Input Capacitance	C_{IN}	8-Pin DIP		60		pF	$f = 1\text{ MHz}$, $V_F = 0\text{ V}$						
		SO-8											
		Widebody		90									
Transistor DC Current Gain	h_{FE}	8-Pin DIP		150			$V_O = 5\text{ V}$, $I_O = 3\text{ mA}$						
		SO-8		130			$V_O = 0.4\text{ V}$, $I_B = 20\text{ }\mu\text{A}$						
		Widebody		180			$V_O = 0.4\text{ V}$, $I_B = 20\text{ }\mu\text{A}$						
				160			$V_O = 5\text{ V}$, $I_O = 3\text{ mA}$						

*For JEDEC registered parts.

**All typicals at $T_A = 25^\circ\text{C}$.

Switching Specifications (AC)

Over recommended temperature ($T_A = 0^\circ\text{C}$ to 70°C), $V_{CC} = 5\text{ V}$, $I_F = 16\text{ mA}$ unless otherwise specified.

Parameter	Sym.	Device	Min.	Typ.**	Max.	Units	Test Conditions		Fig.	Note
Propagation Delay Time to Logic Low at Output	t_{PHL}^*	6N135		0.2	1.5	μs	$T_A = 25^\circ\text{C}$	$R_L = 4.1\text{ k}\Omega$	5, 6, 11	8, 9
		HCPL-0500			2.0					
		HCNW135								
		6N136		0.2	0.8		$T_A = 25^\circ\text{C}$	$R_L = 1.9\text{ k}\Omega$		
		HCPL-2502								
		HCPL-0501								
		HCNW136			1.0					
Propagation Delay Time to Logic High at Output	t_{PLH}^*	6N135		1.3	1.5	μs	$T_A = 25^\circ\text{C}$	$R_L = 4.1\text{ k}\Omega$	5, 6, 11	8, 9
		HCPL-0500			2.0					
		HCNW135								
		6N136		0.6	0.8		$T_A = 25^\circ\text{C}$	$R_L = 1.9\text{ k}\Omega$		
		HCPL-2502								
		HCPL-0501								
		HCNW136			1.0					
Common Mode Transient Immunity at Logic High Level Output	$ CM_H $	6N135	1			$\text{kV}/\mu\text{s}$	$R_L = 4.1\text{ k}\Omega$	$I_F = 0\text{ mA}$, $T_A = 25^\circ\text{C}$, $V_{CM} = 10\text{ V}_{\text{p-p}}$ $C_L = 15\text{ pF}$	12	7, 8, 9
		HCPL-0500		1						
		HCNW135								
		6N136	1				$R_L = 1.9\text{ k}\Omega$			
		HCPL-2502		1						
Common Mode Transient Immunity at Logic Low Level Output	$ CM_L $	6N135	1			$\text{kV}/\mu\text{s}$	$R_L = 4.1\text{ k}\Omega$	$I_F = 16\text{ mA}$, $T_A = 25^\circ\text{C}$, $V_{CM} = 10\text{ V}_{\text{p-p}}$ $C_L = 15\text{ pF}$	12	7, 8, 9
		HCPL-0500		1						
		HCNW135								
		6N136	1				$R_L = 1.9\text{ k}\Omega$			
		HCPL-2502		1						
Bandwidth	BW	6N135/6		9		MHz	See Test Circuit		8, 10	10
		HCPL-2502								
		HCPL-0500/1								
		HCNW135/6		11						

*For JEDEC registered parts.

**All typicals at $T_A = 25^\circ\text{C}$.

Package Characteristics

Over recommended temperature ($T_A = 0^\circ\text{C}$ to 70°C) unless otherwise specified.

Parameter	Sym.	Device	Min.	Typ.*	Max.	Units	Test Conditions	Fig.	Note
Input-Output Momentary Withstand Voltage**	V_{ISO}	8-Pin DIP SO-8	3750			V rms	RH < 50%, t = 1 min., $T_A = 25^\circ\text{C}$		6, 14
		Widebody	5000						6, 15
		8-Pin DIP (Option 020)	5000						6, 12, 15
	I_{I-O}	8-Pin DIP			1	μA	45% RH, t = 5 s, $V_{I-O} = 3 \text{ kVdc}$, $T_A = 25^\circ\text{C}$		6, 16
Input-Output Resistance	R_{I-O}	8-Pin DIP SO-8		10^{12}		Ω	$V_{I-O} = 500 \text{ Vdc}$		6
		Widebody		10^{12}	10^{13}		$T_A = 25^\circ\text{C}$		
				10^{11}			$T_A = 100^\circ\text{C}$		
Input-Output Capacitance	C_{I-O}	8-Pin DIP SO-8		0.6		pF	f = 1 MHz		6
		Widebody		0.5	0.6				

* All typicals at $T_A = 25^\circ\text{C}$.

** The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to the IEC/EN/DIN EN 60747-5-5 Insulation Related Characteristics Table (if applicable), your equipment level safety specification or Avago Application Note 1074 entitled "Optocoupler Input-Output Endurance Voltage," publication number 5963-2203E.

Notes:

- Derate linearly above 70°C free-air temperature at a rate of $0.8 \text{ mA}/^\circ\text{C}$ (8-Pin DIP).
Derate linearly above 85°C free-air temperature at a rate of $0.5 \text{ mA}/^\circ\text{C}$ (SO-8).
- Derate linearly above 70°C free-air temperature at a rate of $1.6 \text{ mA}/^\circ\text{C}$ (8-Pin DIP).
Derate linearly above 85°C free-air temperature at a rate of $1.0 \text{ mA}/^\circ\text{C}$ (SO-8).
- Derate linearly above 70°C free-air temperature at a rate of $0.9 \text{ mW}/^\circ\text{C}$ (8-Pin DIP).
Derate linearly above 85°C free-air temperature at a rate of $1.1 \text{ mW}/^\circ\text{C}$ (SO-8).
- Derate linearly above 70°C free-air temperature at a rate of $2.0 \text{ mW}/^\circ\text{C}$ (8-Pin DIP).
Derate linearly above 85°C free-air temperature at a rate of $2.3 \text{ mW}/^\circ\text{C}$ (SO-8).
- CURRENT TRANSFER RATIO in percent is defined as the ratio of output collector current, $I_{O'}$, to the forward LED input current, I_F , times 100.
- Device considered a two-terminal device: Pins 1, 2, 3, and 4 shorted together and Pins 5, 6, 7, and 8 shorted together.
- Common mode transient immunity in a Logic High level is the maximum tolerable (positive) dV_{CM}/dt on the leading edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a Logic High state (i.e., $V_O > 2.0 \text{ V}$). Common mode transient immunity in a Logic Low level is the maximum tolerable (negative) dV_{CM}/dt on the trailing edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a Logic Low state (i.e., $V_O < 0.8 \text{ V}$).
- The $1.9 \text{ k}\Omega$ load represents 1 TTL unit load of 1.6 mA and the $5.6 \text{ k}\Omega$ pull-up resistor.
- The $4.1 \text{ k}\Omega$ load represents 1 LSTTL unit load of 0.36 mA and $6.1 \text{ k}\Omega$ pull-up resistor.
- The frequency at which the ac output voltage is 3 dB below its mid-frequency value.
- The JEDEC registration for the 6N136 specifies a minimum CTR of 15%. Avago guarantees a minimum CTR of 19%.
- See Option 020 data sheet for more information.
- Use of a $0.1 \mu\text{F}$ bypass capacitor connected between pins 5 and 8 is recommended.
- In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage $\geq 4500 \text{ V rms}$ for 1 second (leakage detection current limit, $I_{I-O} \leq 5 \mu\text{A}$). This test is performed before the 100% Production test shown in the IEC/EN/DIN EN 60747-5-5 Insulation Related Characteristics Table if applicable.
- In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage $\geq 6000 \text{ V rms}$ for 1 second (leakage detection current limit, $I_{I-O} \leq 5 \mu\text{A}$). This test is performed before the 100% Production test shown in the IEC/EN/DIN EN 60747-5-5 Insulation Related Characteristics Table if applicable.
- This rating is equally validated by an equivalent ac proof test.

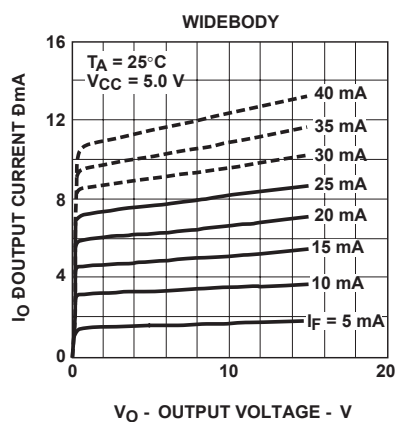
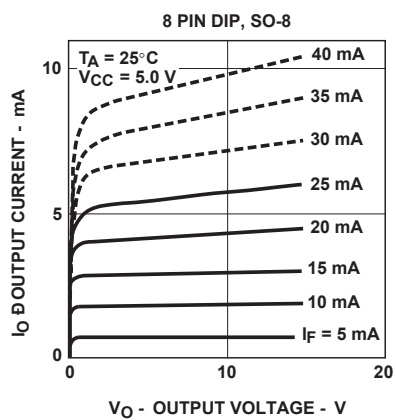


Figure 1. DC and pulsed transfer characteristics.

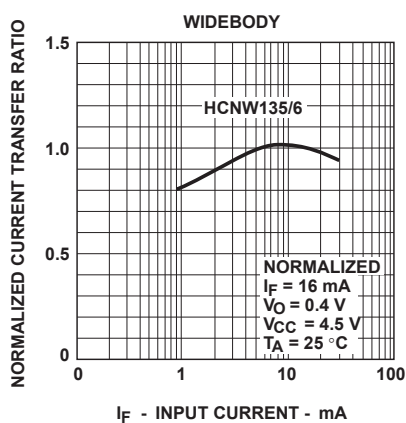
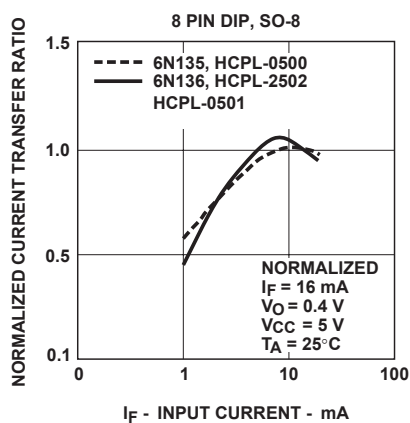


Figure 2. Current transfer ratio vs. input current.

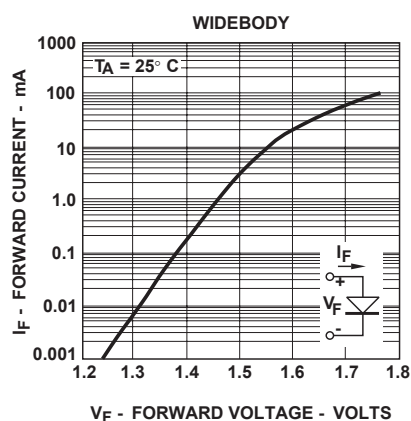
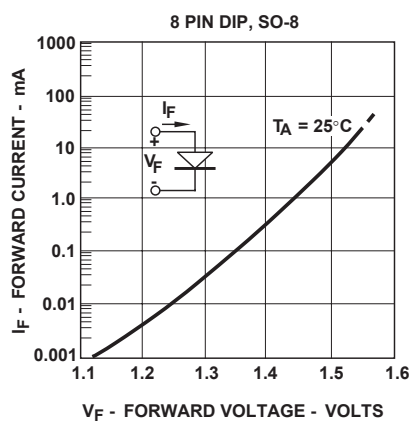


Figure 3. Input current vs. forward voltage.

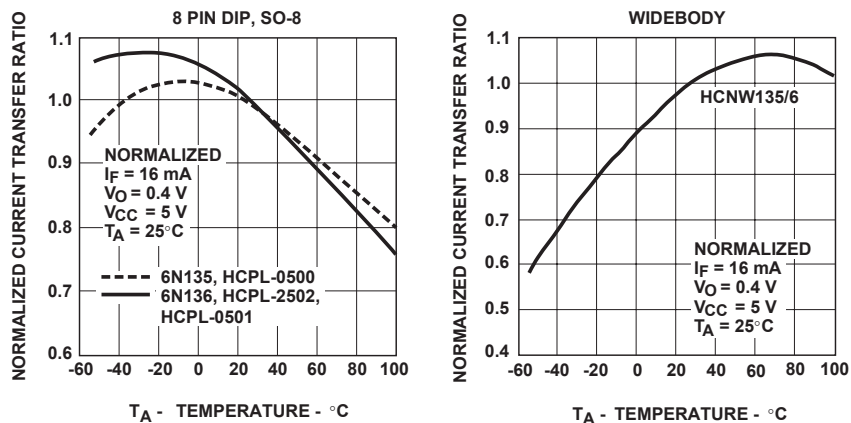


Figure 4. Current transfer ratio vs. temperature.

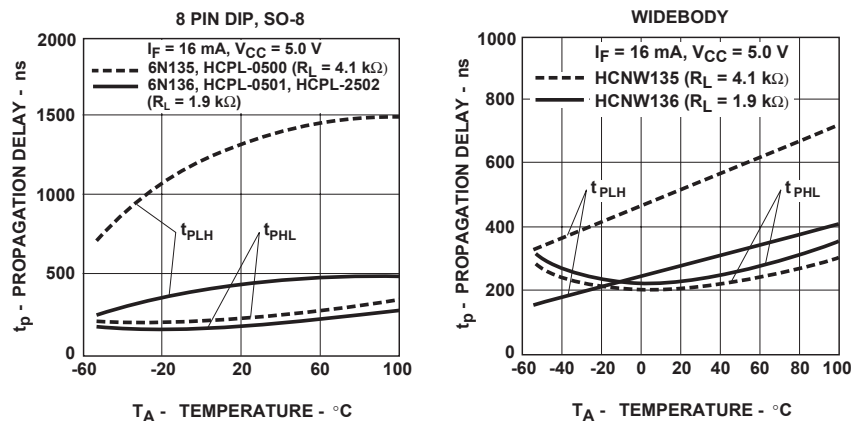


Figure 5. Propagation delay vs. temperature.

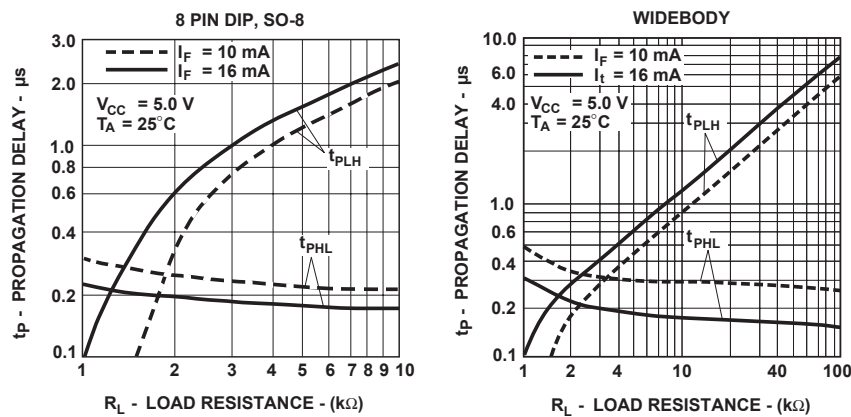


Figure 6. Propagation delay time vs. load resistance.

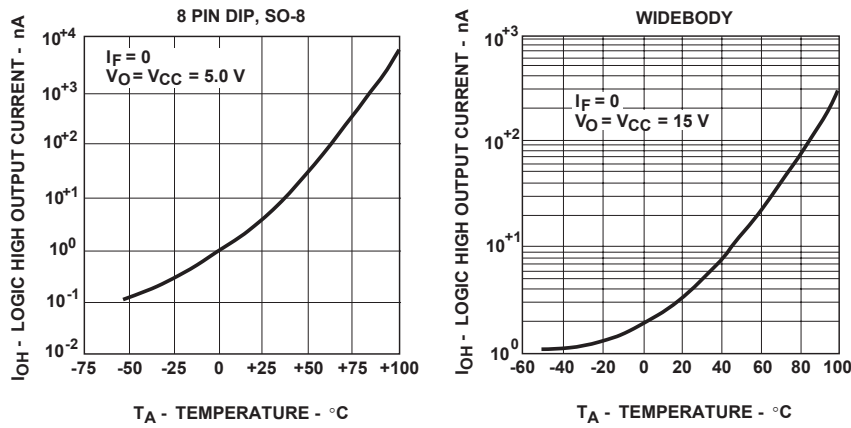


Figure 7. Logic high output current vs. temperature.

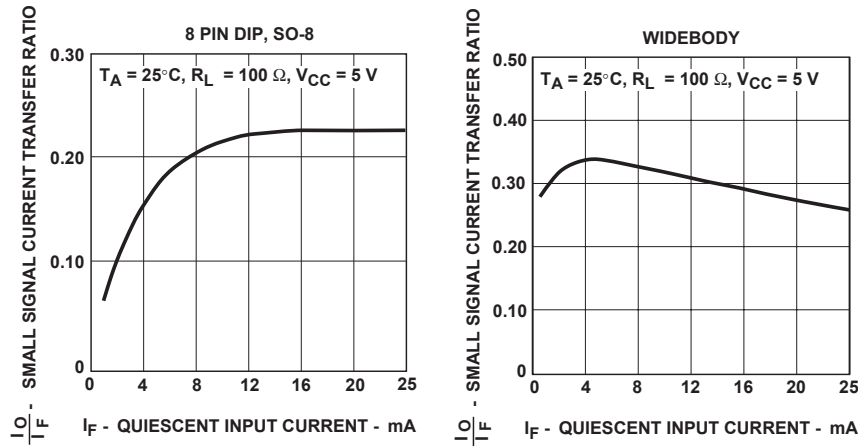


Figure 8. Small-signal current transfer ratio vs. quiescent input current.

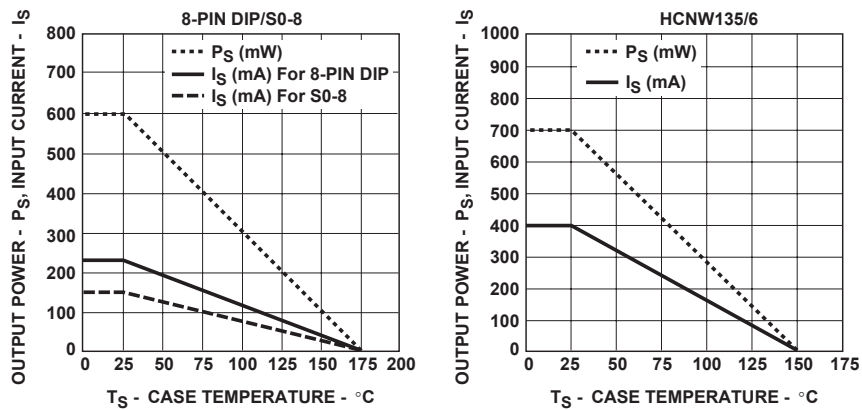


Figure 9. Thermal derating curve, dependence of safety limiting value with case temperature per IEC/EN/DIN EN 60747-5-5.

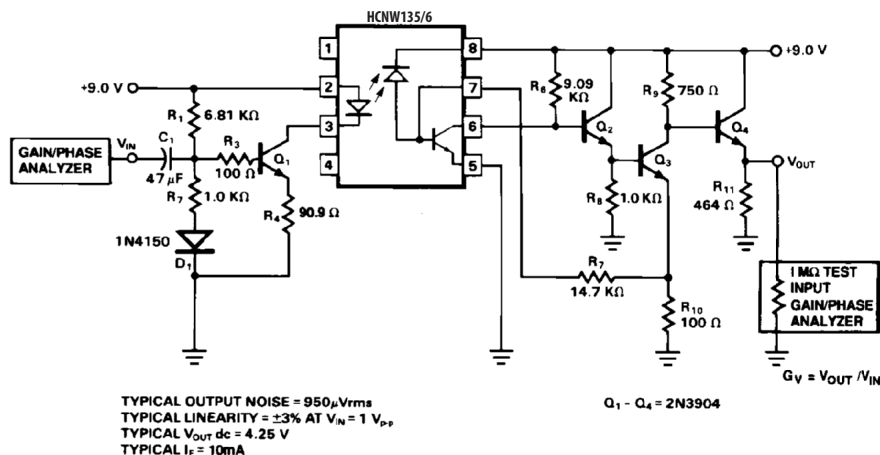
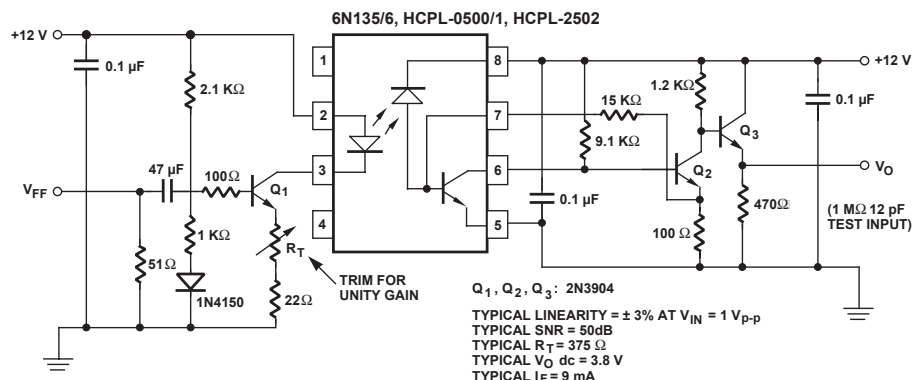
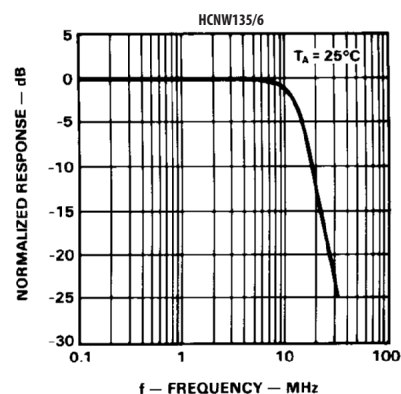
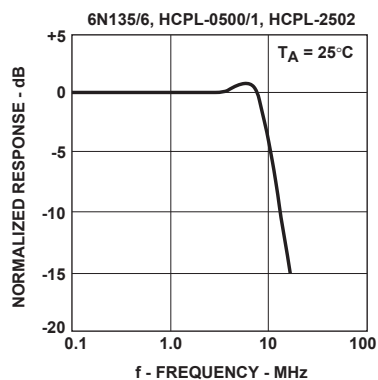


Figure 10. Frequency response

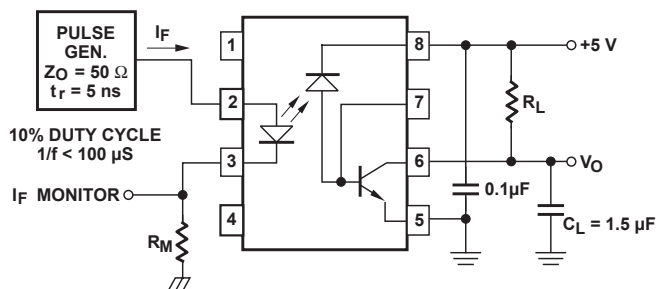
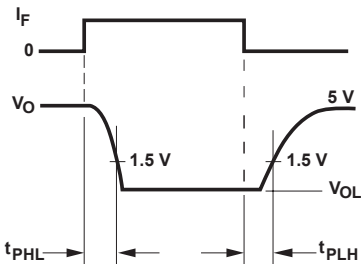


Figure 11. Switching test circuit

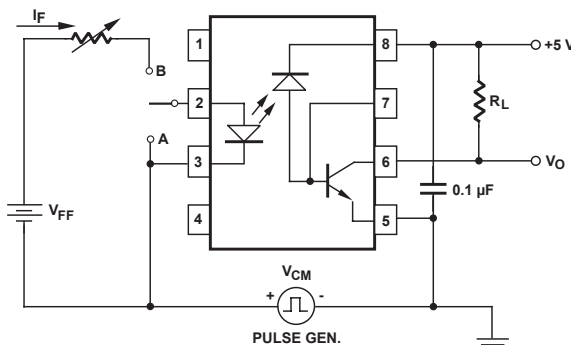
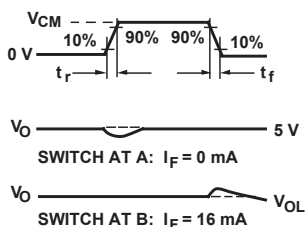


Figure 12. Test circuit for transient immunity and typical waveforms

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